



D8V0X1B2LP

8V ULTRA LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

Product Summary

V _{BR} (Min)	IPP (Max)	Ст (Тур)
9.5V	4A	0.5pF

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications, such as cellular phones, digital cameras, and MP3 players.

Features

- Low Profile Package (0.53mm Max) and Ultra-Small PCB
 Footprint Area (1.08mm × 0.68mm Max) Suitable for Compact
 Portable Electronics
- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±24kV, Contact ±20kV
- One Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripheral

Mechanical Data

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.001 grams (Approximate)

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Bottom View



Device Schematic

Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D8V0X1B2LP-7B	Standard	MP	7	8	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



MP = Product Type Marking Code Bar Denotes Pin 1



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	IPP	4	Α	8/20μs, See Figure 3
ESD Protection—Contact Discharge	V _{ESD_Contact}	±20	kV	IEC 61000-4-2 Standard
ESD Protection—Air Discharge	V _{ESD_Air}	±24	kV	IEC 61000-4-2 Standard

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	RөJA	500	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

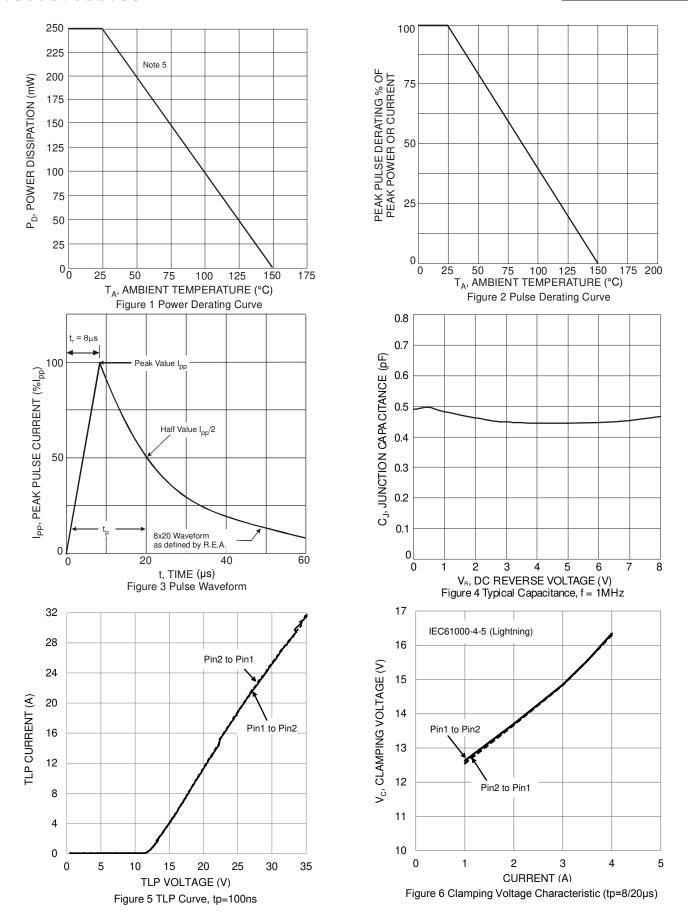
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	V _{RWM}	_	_	8.0	V	_
Reverse Current (Note 6)	IR	_	_	1	μΑ	V _R = 8V
Reverse Breakdown Voltage	V _{BR}	9.5	_	_	V	I _R = 1mA
Reverse Clamping Voltage, Positive Transients	VcL	_	_	15	V	IPP = 1A, tP = 8/20µs
		_	_	18.5	V	IPP = 4A, tP = 8/20µs
Dynamic Resistance	RDYN	_	0.6	_	Ω	I _R = 1A, t _P = 8/20μs
Capacitance	Ст	_	0.5	_	pF	V _R = 0V, f = 1MHz

Notes:

^{5.} Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout per http://www.diodes.com/package-outlines.html.

http://www.diodes.com/package-outlines.html.
6. Short duration pulse test used to minimize self-heating effect.



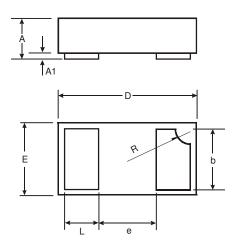




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

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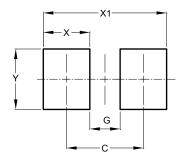


X1-DFN1006-2					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0	0.05	0.03		
b	0.45	0.55	0.50		
D	0.95	1.075	1.00		
E	0.55	0.675	0.60		
е		-	0.40		
Ĺ	0.20	0.30	0.25		
R	0.05	0.15	0.10		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

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Dimensions	Value		
Diffiensions	(in mm)		
С	0.70		
G	0.30		
Х	0.40		
X1	1.10		
Υ	0.70		



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